

# APM2802CG-C-TR-G-VB Datasheet Dual N-Channel 20 V (D-S) MOSFET

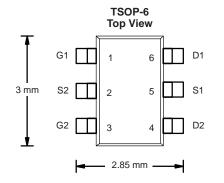
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
20	0.022 at $V_{GS}$ = 4.5 V	6.0	1.8 nC			
	0.028 at V <sub>GS</sub> = 2.5 V	5.0	1.0 HC			

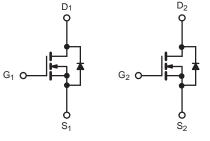
## FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- Trench Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC



COMPLIANT





N-Channel MOSFET

N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 12	v	
	T <sub>C</sub> = 25 °C		6.0		
Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C	I <sub>D</sub>	4.0		
	T <sub>A</sub> = 25 °C	טי ן	3.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	2.8 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	18		
	T <sub>C</sub> = 25 °C		1.17		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	0.95 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		1.6		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	1.0	w	
	T <sub>A</sub> = 25 °C		1.14 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C	1	0.73 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Tempera		260			

#### THERMAL RESISTANCE RATINGS

Parameter		Typical	Maximum	Unit	
t ≤ 5 s	R <sub>thJA</sub>	93	110	°C/W	
ady State	R <sub>thJF</sub>	75	90	0/00	
t	<u>≥</u> 5 5	≥ J S R <sub>thJA</sub>	$\leq 5 \text{ s}$ $R_{\text{thJA}}$ 93	$\leq 5$ R <sub>thJA</sub> 93 110	

Notes:

a. T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 150 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	20			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 ··· A		29		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 4		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.4		1.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current		$V_{DS} = 20 V, V_{GS} = 0 V$			1	μA
	IDSS	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	10			Α
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3.4 \text{ A}$		0.022		Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 3.0 A		0.028		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.4 A		10		S
Dynamic <sup>b</sup>					<b>I</b>	1
Input Capacitance	C <sub>iss</sub>			400		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		55		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			26		
Total Gate Charge		$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 3.4 \text{ A}$		3.7	6	nC
	Q <sub>g</sub>			1.8	3	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 3.4 A		0.74		
Gate-Drain Charge	Q <sub>gd</sub>			0.42		
Gate Resistance	Rg	f = 1 MHz	1	5	10	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			10	20	- ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_{L}$ = 5.6 $\Omega$		15	30	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 2.7$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		10	20	
Fall Time	t <sub>f</sub>			10	20	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 5.6 $\Omega$		15	30	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_{\text{D}}\cong$ 2.7 A, $\text{V}_{\text{GEN}}$ = 10 V, $\text{R}_{g}$ = 1 $\Omega$		10	20	
Fall Time	t <sub>f</sub>			10	20	
Drain-Source Body Diode Characteristi	cs			•	<u>1</u>	
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	$T_{C} = 25 \ ^{\circ}C$		1.2		٨
Pulse Diode Forward Current	I <sub>SM</sub>			18		A
Body Diode Voltage	V <sub>SD</sub>	$I_{S} = 2.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.85	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			10	20	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L = 2.7  A d/dt = 100  A/us  T = 25.90		4	10	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 2.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		6	T	
Reverse Recovery Rise Time	t <sub>b</sub>			4		ns

Notes:

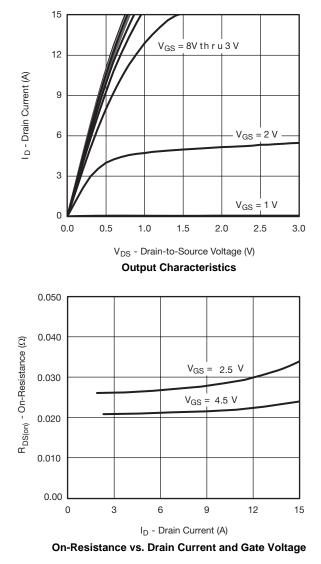
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

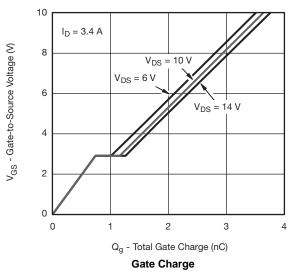
b. Guaranteed by design, not subject to production testing.

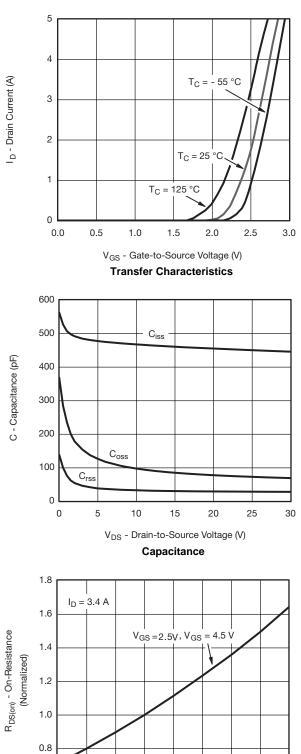
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







0.6

- 50

- 25

0

25

50

T<sub>J</sub> - Junction Temperature (°C)

**On-Resistance vs. Junction Temperature** 

75

100

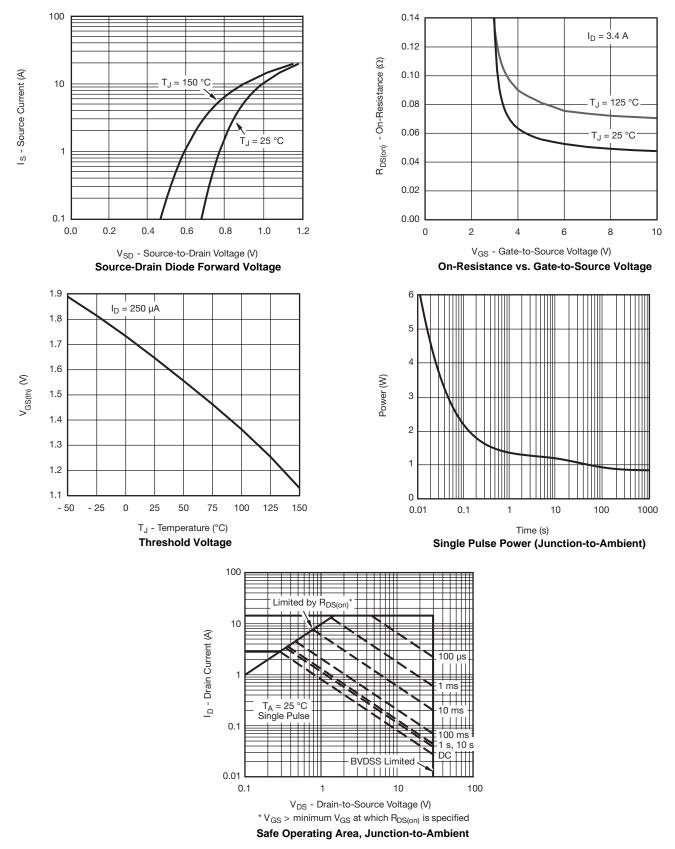
125

150

# APM2802CG-C-TR-G-VB

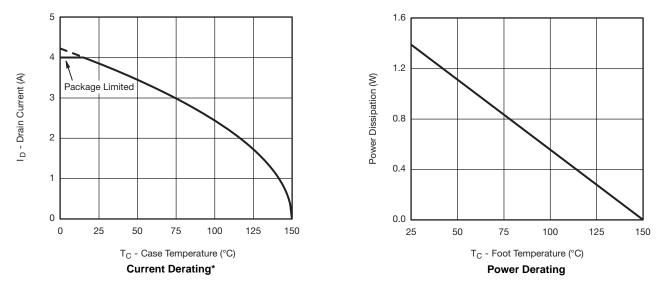


### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





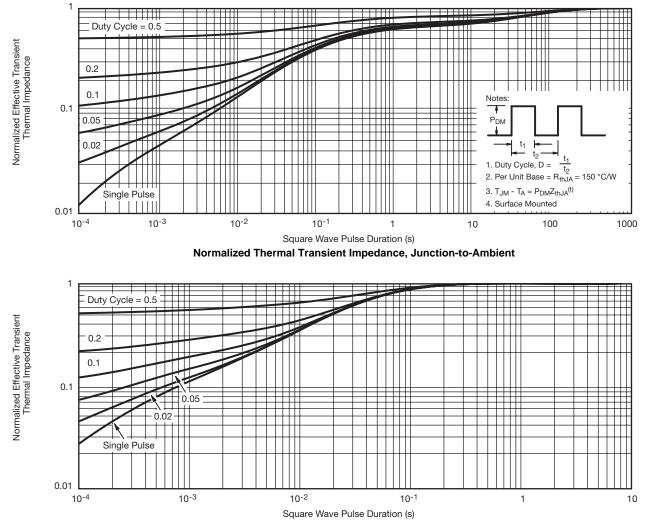
## **TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

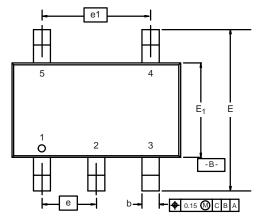


Normalized Thermal Transient Impedance, Junction-to-Foot

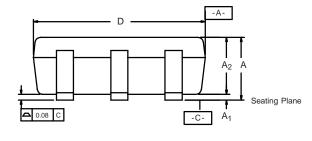
# APM2802CG-C-TR-G-VB

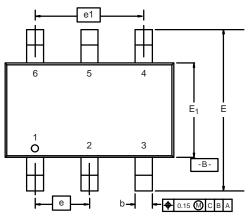


TSOP: 5/6-LEAD JEDEC Part Number: MO-193C

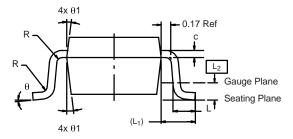








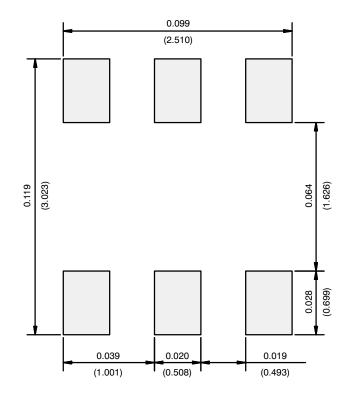
6-LEAD TSOP



	MIL	LIMETER	RS	INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
<b>A</b> <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004	
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
Е	2.70	2.85	2.98	0.106	0.112	0.117	
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067	
е	0.95 BSC			0.0374 BSC			
<b>e</b> <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L <sub>1</sub>		0.60 Ref		0.024 Ref			
L <sub>2</sub>	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
$\theta_1$	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							



## **RECOMMENDED MINIMUM PADS FOR TSOP-6**



Recommended Minimum Pads Dimensions in Inches/(mm)



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